

Features

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent CdV/dt effect decline
- 100% EAS Guaranteed
- Green Device Available

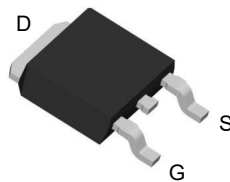
Applications

- High Frequency Point-of-Load Synchronous Buck Converter
- Networking DC-DC Power System
- LED TV Back Light

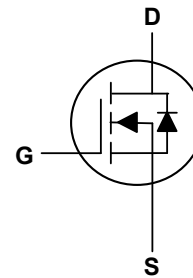
Product Summary



V_{DS}	100	V
I_D	40	A
$R_{DS(ON)}$ (at $V_{GS}=10V$)	20	m Ω
$R_{DS(ON)}$ (at $V_{GS}=4.5V$)	26	m Ω



TO-252 Top View



Absolute Maximum Ratings($T_C=25^\circ C$, unless otherwise noted)

Parameter	Symbol	Rating	Units
Drain-Source Voltage	V_{DS}	100	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current ¹	$I_D@T_C=25^\circ C$	40	A
Pulsed Drain Current ²	I_{DM}	120	A
Single Pulse Avalanche Energy ³	EAS	30	mJ
Total Power Dissipation ⁴	$P_D@T_C=25^\circ C$	72	W
Storage Temperature Range	T_{STG}	-55 to 150	$^\circ C$
Operating Junction Temperature Range	T_J	-55 to 150	$^\circ C$

Thermal Characteristics

Parameter	Symbol	Typ	Max	Unit
Thermal Resistance Junction-Ambient ¹	$R_{\theta JA}$	---	62	$^\circ C/W$
Thermal Resistance Junction-Case ¹	$R_{\theta JC}$	---	1.74	$^\circ C/W$

Electrical Characteristics (T_J=25°C, unless otherwise noted)

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =250uA	100	---	---	V
Static Drain-Source On-Resistance ²	R _{DS(ON)}	V _{GS} =10V, I _D =8A	---	16	20	mΩ
		V _{GS} =4.5V, I _D =6A	---	---	26	mΩ
Gate Threshold Voltage	V _{GS(th)}	V _{GS} =V _{DS} , I _D =250uA	1.0	---	2.5	V
Drain-Source Leakage Current	I _{DSS}	V _{DS} =100V, V _{GS} =0V, T _J =25°C	---	---	1	uA
		V _{DS} =100V, V _{GS} =0V, T _J =55°C	---	---	5	
Gate-Source Leakage Current	I _{GSS}	V _{GS} =±20V, V _{DS} =0V	---	---	±100	nA
Total Gate Charge	Q _g	V _{DS} =50V, V _{GS} =10V, I _D =8A	---	19.8	---	nC
Gate-Source Charge	Q _{gs}		---	2.4	---	
Gate-Drain Charge	Q _{gd}		---	5.3	---	
Gate Plateau Voltage	V _{plateau}		---	3.2	---	V
Turn-On Delay Time	T _{d(on)}	V _{DS} =50V, V _{GS} =10V, R _G =2.2Ω, I _D =10A	---	17.8	---	ns
Rise Time	T _r		---	3.9	---	
Turn-Off Delay Time	T _{d(off)}		---	33.5	---	
Fall Time	T _f		---	3.2	---	
Input Capacitance	C _{iss}	V _{DS} =50V, V _{GS} =0V, f=1MHz	---	1190.6	---	pF
Output Capacitance	C _{oss}		---	194.6	---	
Reverse Transfer Capacitance	C _{rss}		---	4.1	---	

Drain-Source Diode Characteristics

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Continuous Source Current ¹	I _S	V _{GS} <V _{th}	---	---	40	A
Pulsed Source Current	I _{SM}		---	---	120	A
Diode Forward Voltage ²	V _{SD}	V _{GS} =0V, I _S =8A, T _J =25°C	---	---	1.3	V
Reverse Recovery Time	t _{rr}	I _S =8A, di/dt=100A/μs, T _J =25°C	---	50.2	---	nS
Reverse Recovery Charge	Q _{rr}		---	95.1	---	nC
Peak Reverse Recovery Current	I _{rrm}		---	2.5	---	A

Note:

1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
2. The data tested by pulsed, pulse width ≤ 300us, duty cycle ≤ 2%
3. The EAS data shows Max. rating. The test condition is V_{DD}=50V, V_{GS}=10V, L=0.3mH, R_G=25Ω
4. The power dissipation is limited by 150°C junction temperature

Typical Characteristics

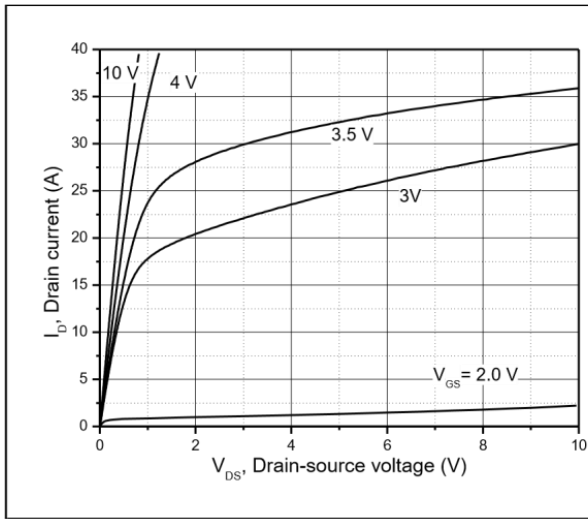


Figure 1, Typ. output characteristics

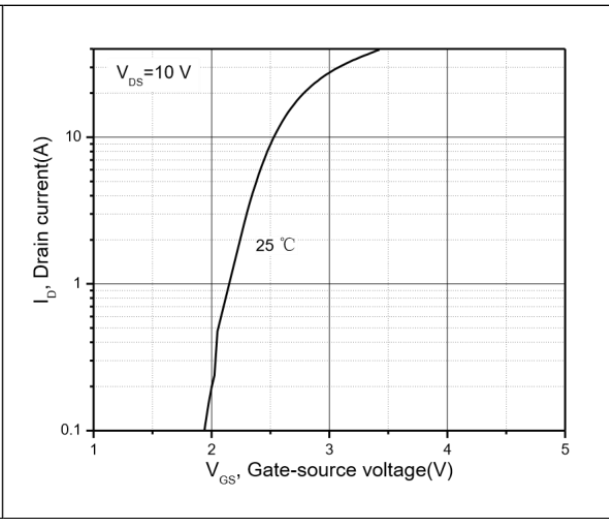


Figure 2, Typ. transfer characteristics

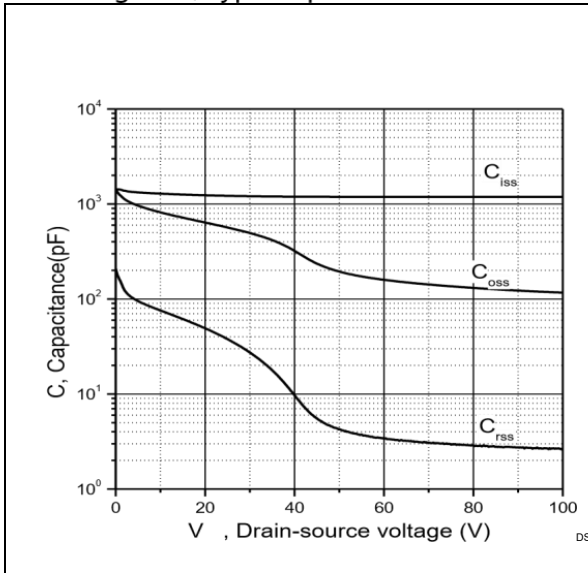


Figure 3, Typ. capacitances

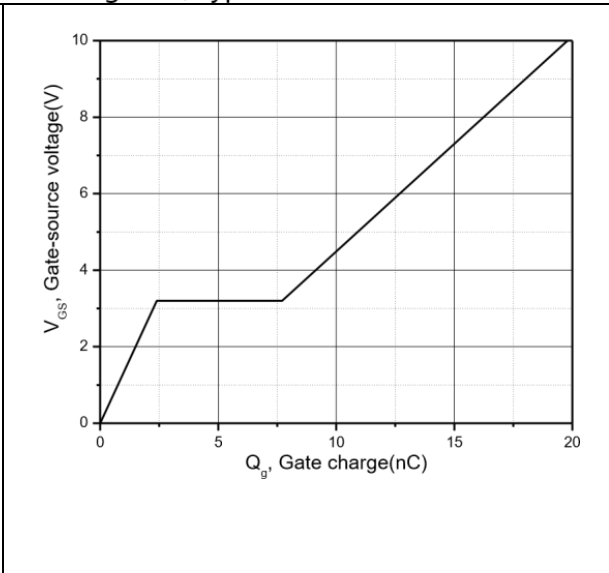


Figure 4, Typ. gate charge

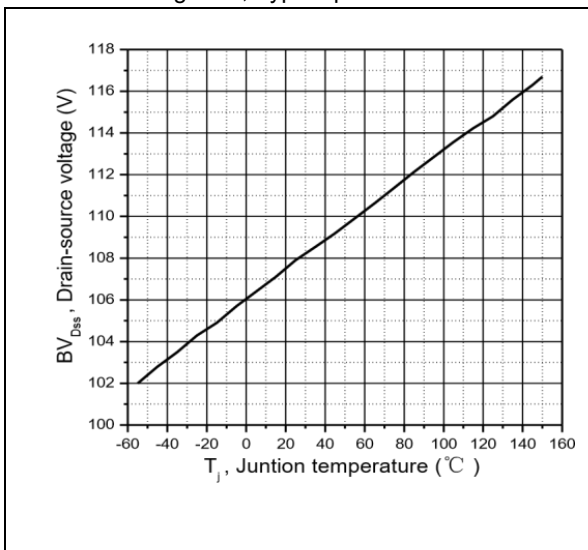


Figure 5, Drain-source breakdown voltage

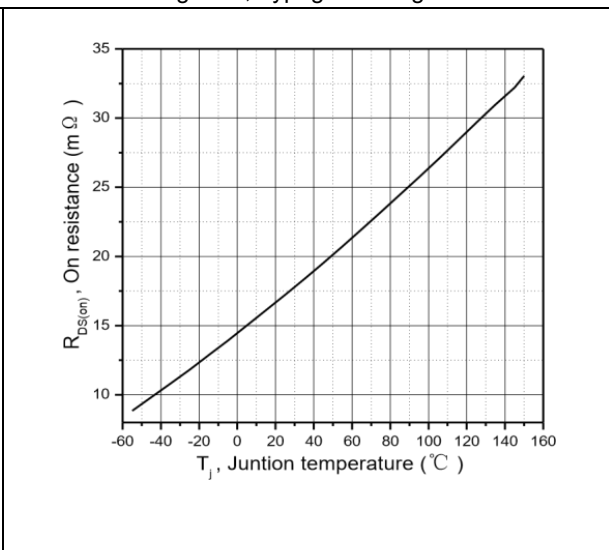


Figure 6, Drain-source on-state resistance

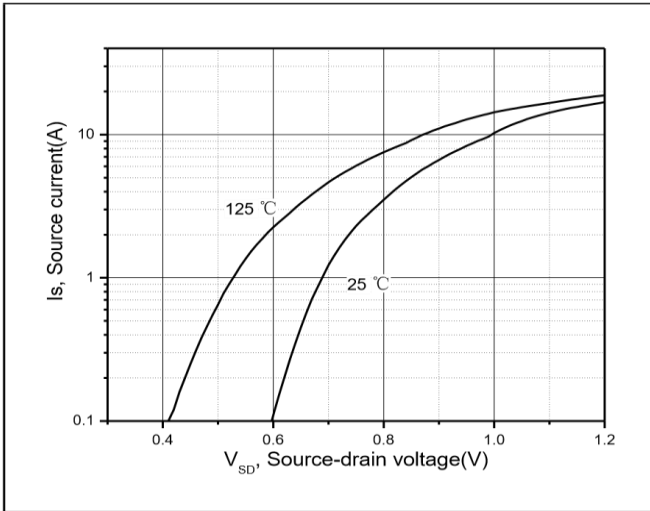


Figure 7, Forward characteristic of body diode

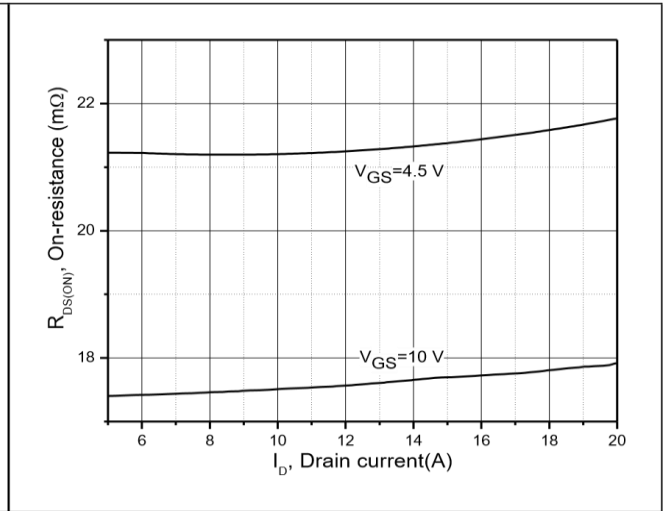


Figure 8, Drain-source on-state resistance

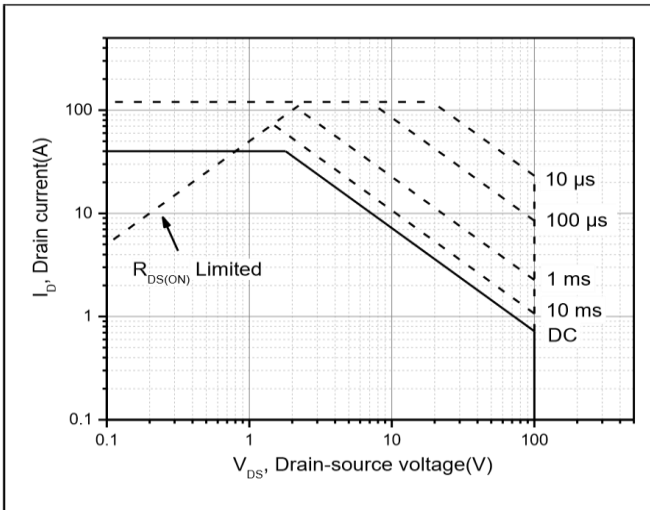


Figure 9, Safe operation area $T_C=25\text{ }^\circ\text{C}$

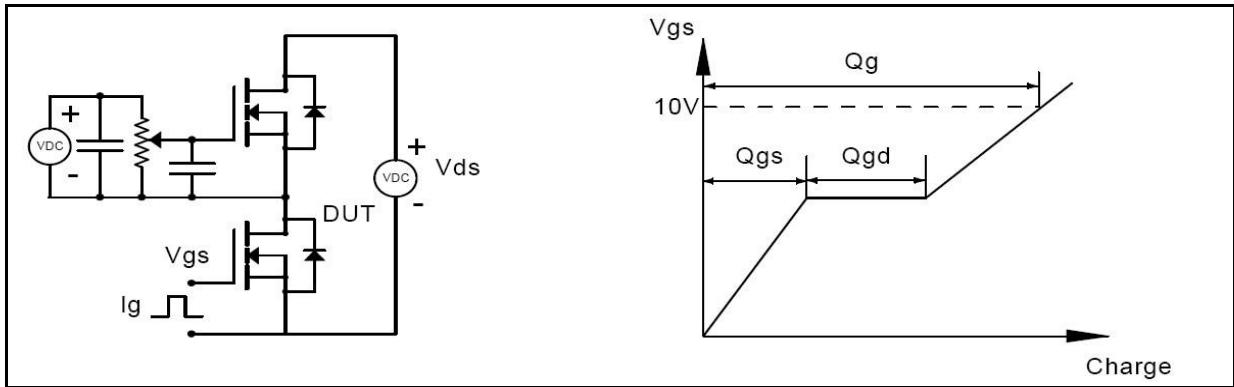


Figure 1, Gate charge test circuit & waveform

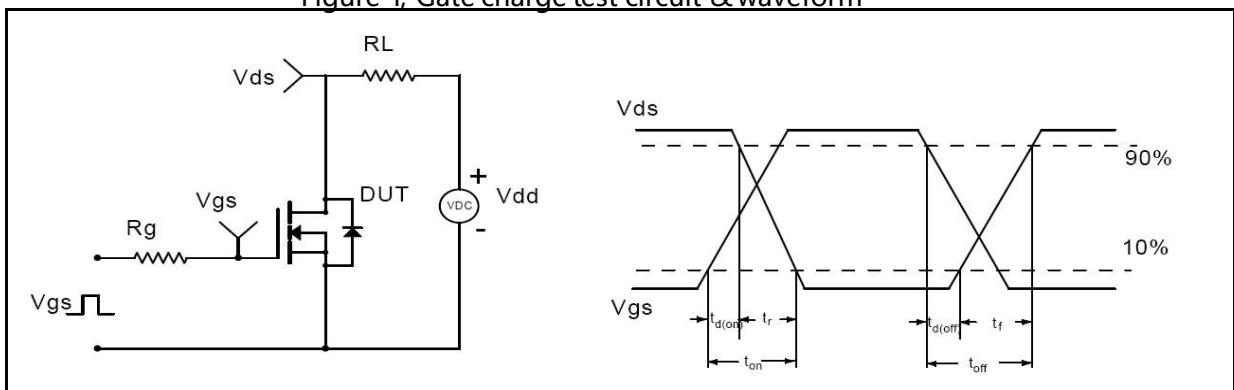


Figure 2, Switching time test circuit & waveforms

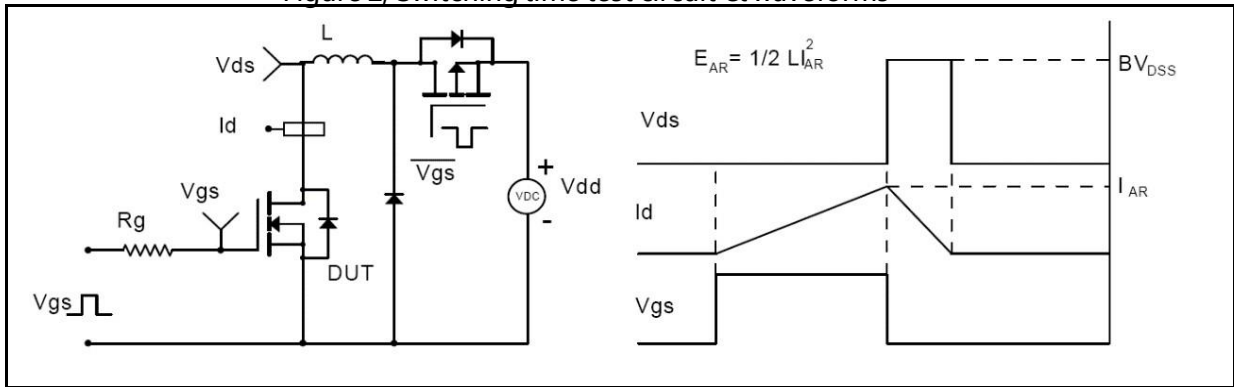


Figure 3, Unclamped inductive switching (UIS) test circuit & waveforms

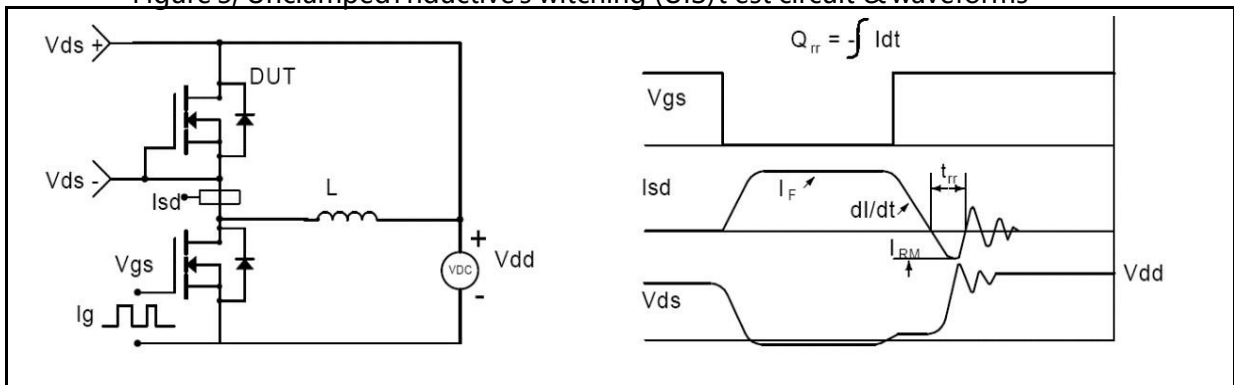
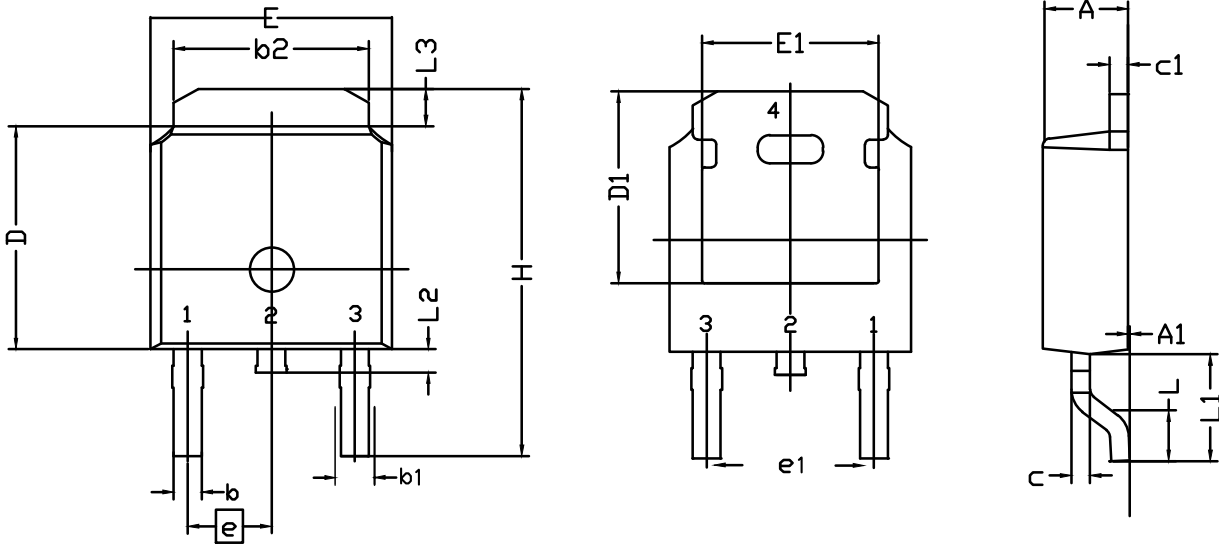


Figure 4, Diode reverse recovery test circuit & waveforms

TO-252 Package Outline Dimensions



Symbol	Dimensions (unit:mm)			Symbol	Dimensions (unit:mm)		
	Min	Typ	Max		Min	Typ	Max
A	2.20	2.30	2.38	E	6.40	6.60	6.731
A₁	0.00	0.10	0.20	E₁	4.40	--	--
b	0.64	0.76	0.89	e	2.286 BSC		
b₁	0.77	0.85	1.14	e₁	4.572 BSC		
b₂	5.00	5.33	5.46	H	9.40	10.00	10.40
c	0.458	0.508	0.610	L	1.40	1.52	1.77
C₁	0.458	0.508	0.620	L₁	--	2.743	--
D	5.98	6.10	6.223	L₂	0.60	0.80	1.01
D₁	5.20	5.25	5.38	L₃	0.90	1.06	1.25